

Features

- Split Gate Trench MOSFET Technology
- · Excellent Package For Heat Dissipation
- · Moisture Sensitivity Level 1
- Halogen Free. "Green" Device (Note 1)
- · Epoxy Meets UL 94 V-0 Flammability Rating
- Lead Free Finish/RoHS Compliant ("P" Suffix Designates RoHS Compliant. See Ordering Information)

Maximum Ratings

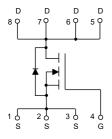
- Operating Junction Temperature Range : -55°C to +150°C
- Storage Temperature Range: -55°C to +150°C
- Thermal Resistance: 50°C/W Junction to Ambient(Steady-State)(Note 2)
- Thermal Resistance: 1.42°C/W Junction to Case(Steady-State)

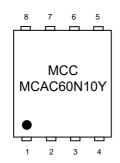
Parameter		Symbol	Rating	Unit	
Drain-Source Voltage		V _{DS}	100	V	
Gate-Source Volltage		V_{GS}	±20	V	
Continuous Drain Current	T _C =25°C	l _D	60	Α	
	T _C =100°C	0.0	38		
Pulsed Drain Current ^(Note 3)		I _{DM}	240	Α	
Total Power Dissipation(Note 4)		P _D	88	W	
Single Pulsed Avalanche Energy ^(Note 5)		E _{AS}	200	mJ	

Note:

- 1. Halogen free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 2. The value of $R_{\theta JA}$ is measured with the device mounted on 1in^2 FR-4 board with 2oz. Copper, in a still air environment with T_A =25°C.
- 3. Repetitive rating; pulse width limited by max. junction temperature.
- 4. P_D is based on max. junction temperature, using junction-case thermal resistance.
- 5. V_{DD} =50V, V_{GS} =10V, R_{G} =25 Ω , L=1mH.

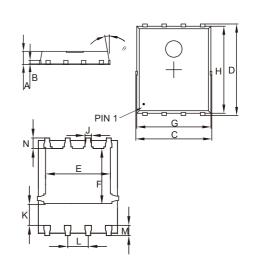
Internal Structure and Marking Code





N-CHANNEL MOSFET

DFN5060



DIMENSIONS						
DIM	INCHES		MM		NOTE	
DIIVI	MIN	MAX	MIN	MAX	NOIL	
Α	0.031	0.047	0.80	1.20		
В	0.010		0.254		TYP.	
С	0.193	0.222	4.90	5.64		
D	0.232	0.250	5.90	6.35		
Е	0.148	0.167	3.75	4.25		
F	0.126	0.154	3.20	3.92		
G	0.189	0.213	4.80	5.40		
Н	0.222	0.239	5.65	6.06		
K	0.045	0.059	1.15	1.50		
J	0.012	0.020	0.30	0.50		
L	0.046	0.054	1.17	1.37		
M	0.012	0.028	0.30	0.71		
N	0.016	0.028	0.40	0.71		

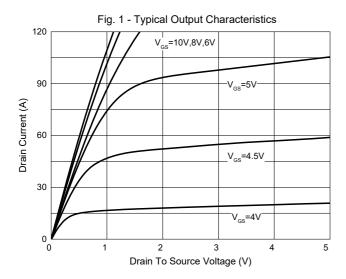


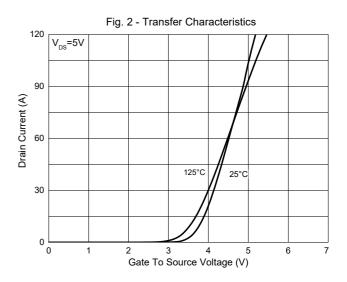
Electrical Characteristics @ 25°C (Unless Otherwise Specified)

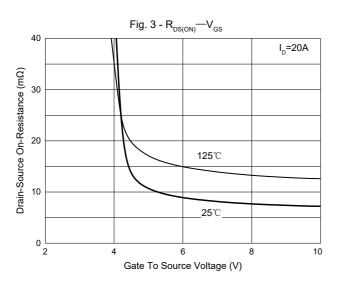
Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Static Characteristics			'		1		
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250μA	100			V	
Gate-Source Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =100V, V _{GS} =0V			1	μA	
Gate-Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	2.2	2.8	3.4	V	
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =10V, I _D =20A		7.2	8.6	mΩ	
Gate Resistance	R_G	f=1MHz, Open drain		0.68		Ω	
Diode Characteristics				•			
Continuous Body Diode Current	Is				60	Α	
Diode Forward Voltage	V _{SD}	V _{GS} =0V, I _S =20A			1.3	V	
Reverse Recovery Time	t _{rr}	L 00A II / II 400A/		51.8		ns	
Reverse Recovery Charge	Q _{rr}	l _F =20A, dl _F /dt=100A/μs		84		nC	
Dynamic Characteristics							
Input Capacitance	C _{iss}			2346			
Output Capacitance	C _{oss}	V _{DS} =50V,V _{GS} =0V,f=1MHz		832		pF	
Reverse Transfer Capacitance	C _{rss}			13			
Total Gate Charge	Q_g			31			
Gate-Source Charge	Q _{gs}	V _{DS} =50V,V _{GS} =10V,I _D =25A		9.6		nC	
Gate-Drain Charge	Q_{gd}			4.2			
Turn-On Delay Time	t _{d(on)}			13			
Turn-On Rise Time	t _r	V _{DS} =50V, V _{GEN} =10V,		4		no	
Turn-Off Delay Time	t _{d(off)}	$R_G=2.2\Omega$, $I_{DS}=25A$		22		ns	
Turn-Off Fall Time	t _f			4			

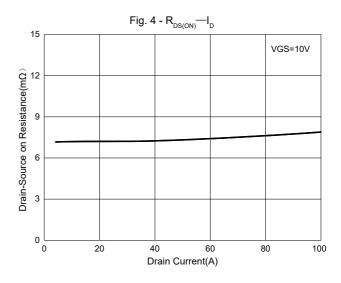


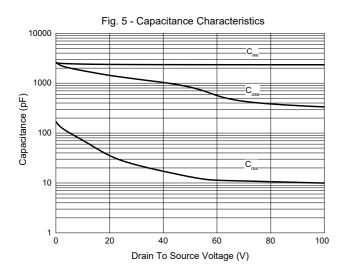
Curve Characteristics

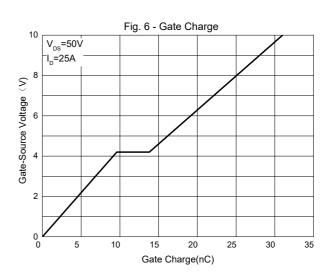






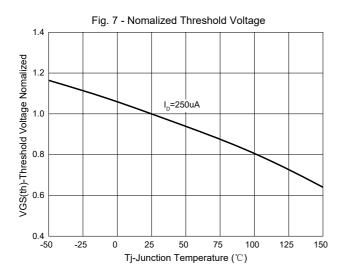


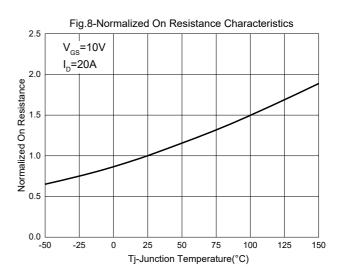


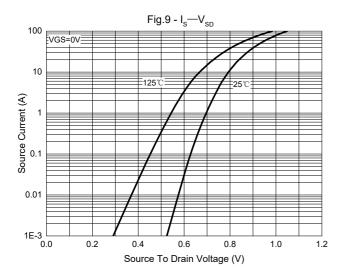


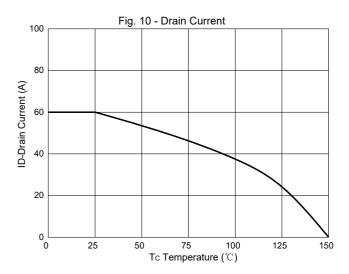


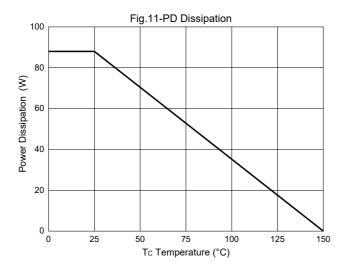
Curve Characteristics





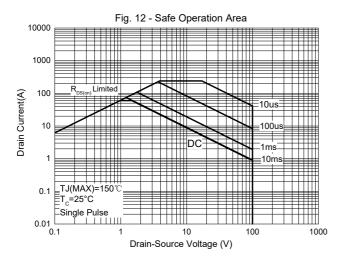


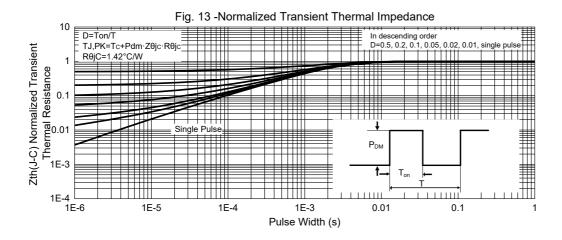






Curve Characteristics







Ordering Information

Device	Packing	
Part Number-TP	Tape&Reel: 5Kpcs/Reel	

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